#### SILICON (Si) POWER MOSFET A CEF85N75



CET MOS

# **CEF85N75**

# 75V A 10mΩ A 86ANote 4 A Si MOSFET

SILICON Si MOSFET ▲ THT type N-channel enhancement mode UL94V-0 rated flame retardant epoxy TO220F-3L package ▲ Electrical insulated mounting tab Super high dense cell density for extremely low R<sub>DS(ON)</sub> High power and current handling capability

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FREE

RoHS



Parameter ( $T_c$ = 25°C, unless otherwise noted)	Characteristics	
Drain-Source Voltage	V <sub>DS</sub>	75V
Gate-Source Voltage	V <sub>GS</sub>	±30V
Continuous Drain Current Note 5	I <sub>D</sub>	86A Note 4
Pulsed Drain Current Note 5	IDM Note 6	344A Note 4
Maximum Power Dissipation at T <sub>c</sub> = 25°C	PD	75W
Power Dissipation Derating above 25°C	ΔP <sub>D</sub>	0.5W/°C
Single Pulsed Avalanche Energy Note 4	E <sub>AS</sub>	880mJ
Single Pulsed Avalanche Current Note 4	I <sub>AS</sub>	45A
Operating and Storage Temperature Range	Т <sub>Ј</sub> , Т <sub>STG</sub>	-55°C to +175°C

### **THERMAL CHARACTERISTICS**

Parameter	Symbol	Limit
Thermal Resistance, Junction-to-Case	R <sub>TH_JC</sub>	2°C/W
Thermal Resistance, Junction-to-Ambient	R <sub>th_ja</sub>	65°C/W

### **APPLICATIONS**

Audio	Battery Management	Industrial	Power	UPS
Amplifier	Systems	Control	Inverter	
<b>(</b> )	+ 4 -			

### **PIN DESCRIPTION**

Circuit Diagram	Outline • Front View	Pin No.	Description
G (1)		1	Gate
G (1)		2	Drain
S (3)		3	Source

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### **ELECTRICAL CHARACTERISTICS** A T<sub>c</sub> = 25°C, unless otherwise noted

ltem	Condition	Symbol	Min.	Тур.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_{D} = 250 \mu A$	BV <sub>DSS</sub>	75			V
Zero Gate Voltage Drain Current	$V_{DS} = 75V, V_{GS} = 0V$	I <sub>DSS</sub>			1	μΑ
Gate Body Leakage Current, Forward	$V_{GS}$ = 30V, $V_{DS}$ = 0V	I <sub>GSSF</sub>			100	nA
Gate Body Leakage Current, Reverse	$V_{GS}$ = -30V, $V_{DS}$ = 0V	I <sub>GSSR</sub>			-100	nA
On Characteristics Note 2						
Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250 \mu A$	V <sub>GS(th)</sub>	2		4	V
Static Drain-Source On-Resistance	$V_{GS}$ = 10V, $I_{D}$ = 40A	R <sub>DS(ON)</sub>		10	12	mΩ
Dynamic Characteristics Note 3						
Forward Transconductance	V <sub>DS</sub> = 15V, I <sub>D</sub> = 40A	<b>g</b> FS		45		S
Input Capacitance	$V_{DS}$ = 25V, $V_{GS}$ = 0V, f = 1MHz	C <sub>ISS</sub>		3500		рF
Output Capacitance	$V_{DS}$ = 25V, $V_{GS}$ = 0V, f = 1MHz	Coss		715		рF
Reverse Transfer Capacitance	$V_{DS}$ = 25V, $V_{GS}$ = 0V, f = 1MHz	C <sub>RSS</sub>		70		pF
Switching Characteristics Note 3						
Turn-On Delay Time	$V_{\text{DD}}$ = 37.5V, $V_{\text{GS}}$ = 10V, $I_{\text{D}}$ = 45A, $R_{\text{G}(\text{ext})}$ = 4.7 $\Omega$	t <sub>D(ON)</sub>		28	56	ns
Turn-On Rise Time	$V_{\text{DD}}$ = 37.5V, $V_{\text{GS}}$ = 10V, $I_{\text{D}}$ = 45A, $R_{\text{G}(\text{ext})}$ = 4.7 $\Omega$	t <sub>R</sub>		9	18	ns
Turn-Off Delay Time	$V_{\text{DD}}$ = 37.5V, $V_{\text{GS}}$ = 10V, $I_{\text{D}}$ = 45A, $R_{\text{G}(\text{ext})}$ = 4.7 $\Omega$	$t_{D(OFF)}$		83	166	ns
Turn-Off Fall Time	$V_{\text{DD}}$ = 37.5V, $V_{\text{GS}}$ = 10V, $I_{\text{D}}$ = 45A, $R_{G(ext)}$ = 4.7 $\Omega$	t <sub>F</sub>		10	20	ns
Total Gate Charge	$V_{DS} = 60V, V_{GS} = 10V, I_D = 75A$	$Q_{G}$		90	119	nC
Gate Source Charge	$V_{DS} = 60V, V_{GS} = 10V, I_D = 75A$	Q <sub>GS</sub>		19		nC
Gate Drain Charge	$V_{DS}$ = 60V, $V_{GS}$ = 10V, $I_{D}$ = 75A	$\mathbf{Q}_{GD}$		23		nC
Drain-Source Diode Characteristics and	nd Maximum Ratings					
Drain-Source Diode Forward Current		١ <sub>s</sub>			86	A
Drain-Source Diode Forward Voltage Note 2	V <sub>GS</sub> = 0V, I <sub>S</sub> = 40A	$V_{\text{SD}}$			1.5	V

Notes

1: Repetitive Rating: Pulse width limited by maximum junction temperature

2: Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.

3: Guaranteed by design, not subject to production testing.

4: L = 0.87 mH,  $I_{AS} = 45 \text{ A}$ ,  $V_{DD} = 38 \text{ V}$ ,  $R_G = 25 \Omega$ , Starting  $T_J = 25^{\circ}\text{C}$ 

5: Limited only by maximum temperature allowed.

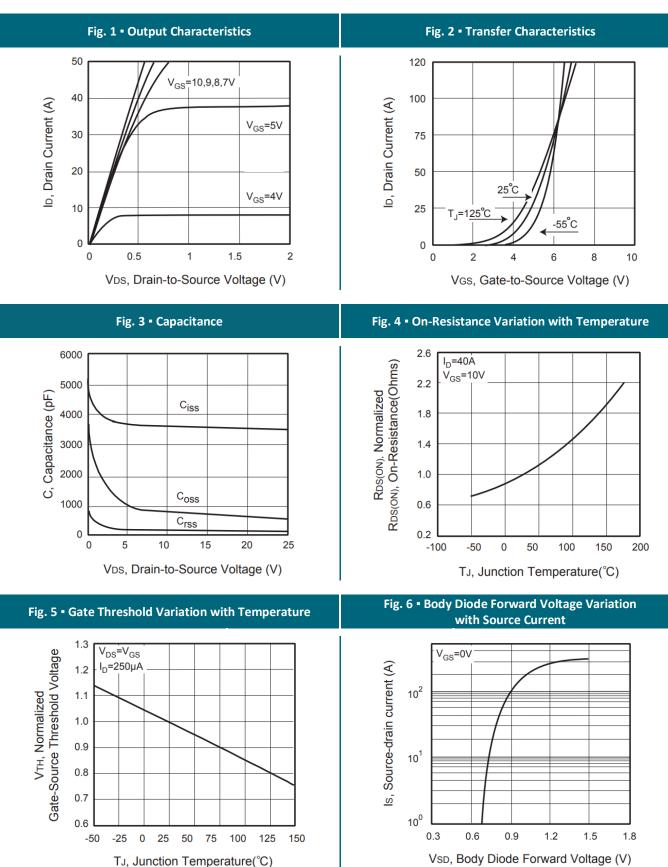
6: Pulse width limited by safe operating area.



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# **REFERENCE DATA ▲ TYPICAL DEVICE PERFORMANCE**

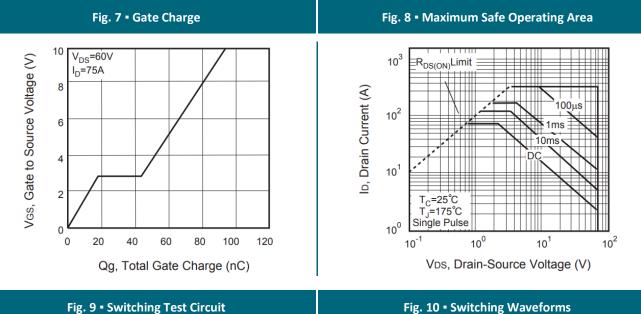


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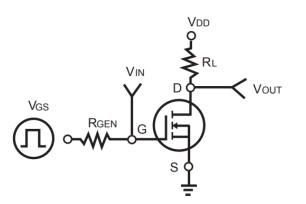


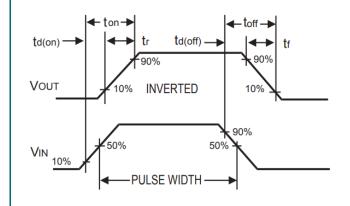
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# **REFERENCE DATA A TYPICAL DEVICE PERFORMANCE**

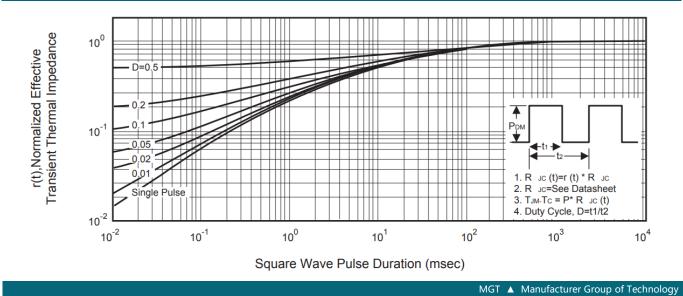


#### Fig. 9 - Switching Test Circuit



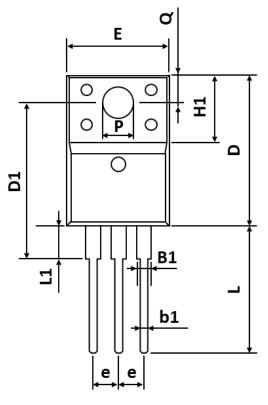


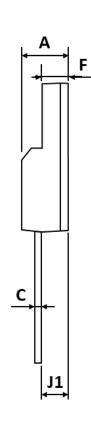
#### Fig. 12 • Normalized Thermal Transient Impedance Curve





### **PACKAGE OUTLINE**





Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
А	4.500	-	5.000
B1	1.000	-	1.500
b1	0.700	-	0.950
С	0.420	-	0.700
D	15.670	-	16.070
D1	14.800	-	16.000
E	9.960	-	10.360
е	2.340	-	2.740
F	2.340	-	2.740
H1	6.480	-	6.900
J1	2.550	-	2.950
L	12.080	-	13.480
L1	2.230	-	3.650
Q	3.100	-	3.500
Р	2.980	-	3.380

# **ORDERING INFORMATION**

Part Number	Package	Packing	Tube Qty.	Inner Box Qty.	Outer Box Qty.
CEF85N75	TO-220F-3L	Tube	50pcs	1,000pcs	4,000pcs

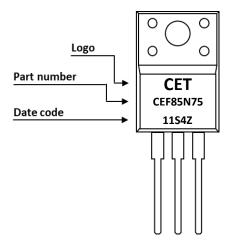


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### **PART MARKING**



# DATE CODE

Example: 11S4Z



| Product Type Z: Pb-free G: Green Product

Coding list for "Day"									
<b>1</b>	<b>2</b>	<b>3</b>	<b>4</b>	<b>5</b>	<b>6</b>	<b>7</b>	<b>8</b>	<b>9</b>	<b>A</b>
01	02	03	04	05	06	07	08	09	10
<b>B</b>	<b>C</b>	<b>D</b>	<b>E</b>	<b>F</b>	<b>G</b>	<b>H</b>	┃	<b>J</b>	<b>K</b>
11	12	13	14	15	16	17	18	19	20
<b>L</b>	<b>M</b>	<b>N</b>	<b>0</b>	<b>P</b>	<b>Q</b>	<b>R</b>	<b>S</b>	<b>T</b>	<b>U</b>
21	22	23	24	25	26	27	28	29	30
<b>V</b> 31									

Coding list for "Month"

<b>1</b> Jan	<b>2</b> Feb		5 May	
<b>7</b>	<b>8</b>	<b>A</b>	<b>B</b>	<b>C</b>
Jul	Aug	Oct	Nov	Dec

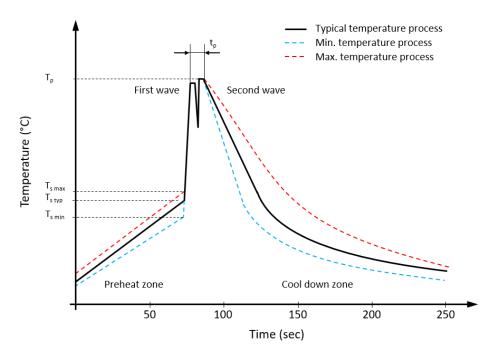
Coding list for "Year"







# **RECOMMENDED WAVE SOLDERING PROFILE A THT PACKAGE**



#### Classification wave soldering profile ▲ Refer to EN 61760-1: 2006

Profile Features		Value 🛦 Sn-Pb Assembly	Value 🔺 Pb-free Assembly
Preheat temperature min.	$T_{smin}$	100 °C	100 °C
Preheat temperature typical	T <sub>s typ</sub>	120 °C	120 °C
Preheat temperature max.	$T_{s max}$	130 °C	130 °C
Preheat time $t_s$ from $T_{s min}$ to $T_{s max}$	ts	70 seconds	70 seconds
Peak temperature	Tp	235 °C to 260 °C	245 °C to 260 °C
Time of actual peak temperature	t <sub>p</sub>	Max. 10 seconds Max. 5 second each wave	Max. 10 seconds Max. 5 second each wave
Ramp-down date min.		~ 2 °C/second	~ 2 °C/second
Ramp-down rate typical		~ 3.5 °C/second	~ 3.5 °C/second
Ramp-down rate max.		~ 5 °C/second	~ 5 °C/second
Time 25°C to 25°C		4 minutes	4 minutes



# **REVISION TABLE**

Revision	Date	Status	Notes
001	30/09/2022	Initial release	Initial publication

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